

In re Application of:
Nguyen, et al.

Group Art Unit: 2823

Examiner: Khiem D. Nguyen


For: Selective Etching of
Organosilicate Films Over
Silicon Oxide Stop Etch
Layers

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

CERTIFICATE OF MAILING OR TRANSMISSION

I hereby certify that this correspondence is being deposited or with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450, or electronically transmitted to the U.S. Patent and Trademark Office via EFS-Web to the attention of the Commissioner for Patents, on the date shown below.

11/7/06 

Date Signature

RESPONSE TO OFFICE ACTION DATED AUGUST 8, 2006

In response to the Office Action dated August 8, 2006, having a shortened statutory period for response set to expire on November 8, 2006, please enter this response and reconsider the claims pending in the application for the reasons discussed below. Although Applicants believe that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/005619/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

The Pending Claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 6 of this paper.